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- 3-State Outputs Drive Bus Lines Directly
- Encodes 8 Data Lines to 3-Line Binary (Octal)
- Applications Include:

   N-Bit Encoding
   Code Converters and Generators
- Typical Data Delay . . . 15 ns
- Typical Power Dissipation . . . 60 mW

#### description

These TTL encoders feature priority decoding of the inputs to ensure that only the highest-order data line is encoded. The 'LS348 circuits encode eight data lines to three-line (4-2-1) binary (octal). Cascading circuitry (enable input E1 and enable output E0) has been provided to allow octal expansion. Outputs A0, A1, and A2 are implemented in three-state logic for easy expansion up to 64 lines without the need for external circuitry. See Typical Application Data.

#### **FUNCTION TABLE**

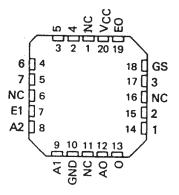
	INPUTS							Ol	JTPU	TS			
EI	0	1	2	3	4	5	6	7	A2	A1	AO	GS	EO
Н	Х	Х	Х	Х	Χ	X	X	X	Z	Z	Z	Н	Н
L	Н	Н	Н	Н	Н	Н	Н	Н	z	Z	Z	н	L
L	Х	Χ	Χ	Х	Х	Χ	Х	L	L	L	L	L	н
L	Х	Х	Χ	Х	Х	Х	L	Н	L	L	Н	L	н
L	Х	Χ	Χ	Χ	Х	L	Н	Н	L	Н	L	L	н
L	Х	Х	Χ	Х	L	Н	Н	Н	L	Н	Н	L	н
L	Ϋ́	Χ	Χ	L	Н	Н	Н	Н	н	L	L	L	н
L	Х	Х	L	Н	Н	Н	Н	Н	н	L	н	L	н
L	Х	L	Н	H	Н	Н	Н	Н	н	Н	L	L	н
L	L	Н	Н	Н	H	Н	Н	Н	Н	Н	Н	L	н

H = high logic level, L = low logic level, X = irrelevant

SN54LS348 . . . J OR W PACKAGE SN74LS348 . . . D OR N PACKAGE (TOP VIEW)

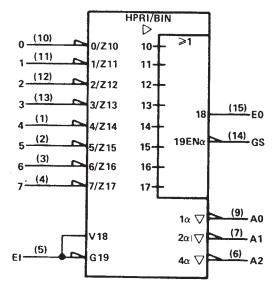
4 🛮 1	U <sub>16</sub> V <sub>CC</sub>
5 🛮 2	15 EO
6 □3	14 🛮 GS
7 🛮 4	13 3
E1 ∏5	12 2
A2 🛮 6	11 🛮 1
A1 □7	10 🛮 0
GND 8	9 🗌 AO

# SN54LS348 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

## logic symbol<sup>†</sup>



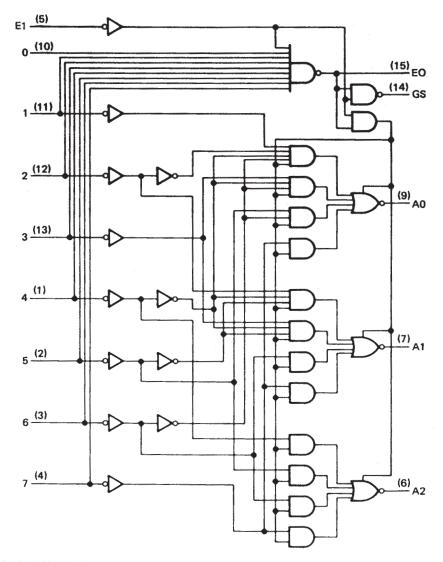
<sup>&</sup>lt;sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.



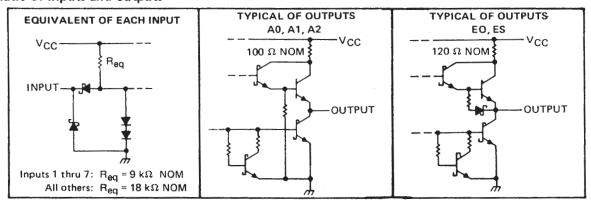
Z = high-impedance state

### logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

## schematic of inputs and outputs





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# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Operating free-air temperature range	SN54LS348
	SN74LS348
Storage temperature range	

NOTE 1: Voltage values are with respect to network ground terminal.

## recommended operating conditions

		SN54LS348			SN74LS348			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>		4.5	5	5.5	4.75	5	5,25	V
High-level output current, IOH	A0, A1, A2			-1			-2.6	mA
thightevel or that carrent 10H	EO, GS			-400	-1 -2. 400 -40	-400	μΑ	
Low-level output current, IOI	A0, A1, A2			12			24	mA
	EO, GS			4			8	mA
Operating free-air temperature, TA		-55		125	0		70	°C

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CO	SN54LS348			SN74LS348			415117	
	TARAMETER	TEST COI	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNI.		
VIH High-level input voltage					2			2			V
V <sub>1L</sub> Low-level input voltage						**	0.7			0.8	V
VIK	Input clamp voltage	V <sub>CC</sub> = MIN,	I <sub>1</sub> = -18 mA			-1.5			-1.5	V	
	High-level	A0, A1, A2	V <sub>CC</sub> = MIN,	I <sub>OH</sub> = -1 mA	2.4	3.1					
VOH	output voltage		V <sub>IH</sub> = 2 V,	I <sub>OH</sub> = -2.6 mA				2.4	3,1		V
		EO, GS	VIL = VILmax	I <sub>OH</sub> = -400 μA	2.5	3.4		2.7	3.4		
		A0, A1, A2	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = V <sub>IL</sub> max	I <sub>OL</sub> = 12 mA		0.25	0.4		0.25	0.4	V
VOL	Low-level Output voltage			OL = 24 mA					0,35	0.5	
OL		EO, GS		<sup>1</sup> OL = 4 mA		0.25	0.4		0.25	0.4	
				I <sub>OL</sub> = 8 mA					0,35	0.5	
loz	Off-State (high-impedance	A0, A1, A2	V <sub>CC</sub> = MAX,	V <sub>O</sub> = 2.7 V		<del></del>	20			20	
102	state) output current	A0, A1, A2	V <sub>IH</sub> = 2 V	V <sub>O</sub> = 0.4 V			-20			-20	μ/
11	Input current at maximum Inputs 1 thru 7		1/ 14A				0.2			0.2	
'1	input voltage	All other inputs	V <sub>CC</sub> = MAX,	V  = / V			0.1			0.1	mA
ин	High-level input current	Inputs 1 thru 7		V 07V			40			40	Ι.
чн	riigii-level iriput current	All other inputs	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V			20			20	μA
111	Low-level input current	Inputs 1 thru 7		V <sub>I</sub> = 0.4 V			-0.8			-0.8	
'11	Low-level input current	All other inputs	VCC = MAX.				-0.4			-0.4	i m
los	Short-circuit output current §	Outputs A0, A1, A2	V MAY		-30		-130	-30		-130	T
.02	onore oneuri output current o	Outputs EO, GS	V <sub>CC</sub> = MAX		-20		-100	-20		-100	m
Icc	Supply current		V <sub>CC</sub> = MAX,	Condition 1		13	25		13	25	
.00	ouppry current		See Note 2	Condition 2		12	23		12	23	3 m

For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: ICC (condition 1) is measured with inputs 7 and EI grounded, other inputs and outputs open. ICC (condition 2) is measured with all inputs and outputs open.



 $<sup>^{\</sup>ddagger}$  All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}$  C.

<sup>§</sup>Not more than one output should be shorted at a time.

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## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ} \text{ C}$

PARAMETER <sup>†</sup>	FROM (INPUT)	TO (OUTPUT)	WAVEFORM	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ФLН	1 thru 7	A0, A1, or A2	In-phase		111	11	17	ns
tPHL.	1 11114 /	A0, A1, 01 A2	output	C. = 45 = 5		20	30	112
ФLН	1 thru 7	A0, A1, or A2	Out-of-phase	C <sub>L</sub> ≈ 45 pF,		23	35	ns
<b>tPHL</b>	1 thru /	AU, A1, or A2	output	R <sub>L</sub> = 667 Ω, See Note 3		23	35	113
ФZН	Et	A0, A1, or A2		See 14016 2		25	39	ns
ΨZL	] '	70, 71, 01 72				24	41	] ""
<b>tPLH</b>	0 thru 7	EO	Out-of-phase			11	18	ns
<b>tPHL</b>			output	CL = 15 pF RL = 2 kΩ,		26	40	
<b>tPLH</b>		GS	In-phase			38	55	ns
tPHL	O and /		output			9	21	1 ""
<b>tPLH</b>	EI	GS	In-phase	See Note 3		11	17	
<b>tPHL</b>	1 -	43	output	See Note 3		14	36	ns
ФLН	EI	EO	In-phase			17	26	
tPHL	1 "		output			25	40	ns
<sup>t</sup> PHZ	EI	A0, A1, or A2		CL = 5 pF		18	27	
<b>tPLZ</b>	] -'	70, 71, 01 72		R <sub>L</sub> = 667 Ω		23	35	ns

<sup>†</sup> tpLH = propagation delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

## TYPICAL APPLICATION DATA

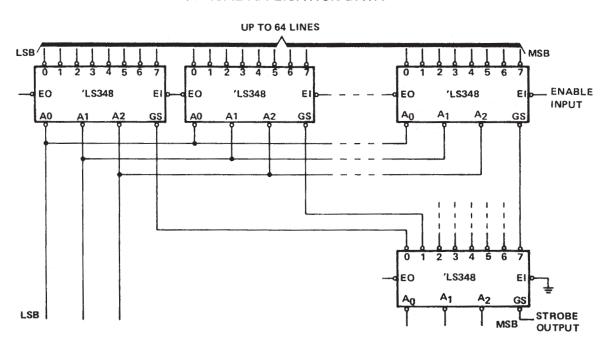


FIGURE 1-PRIORITY ENCODER WITH UP TO 64 INPUTS.



tpHL = propagation delay time, high-to-low-level output

tpzH = output enable time to high level

tpzL = output enable time to low level

tpHZ = output disable time from high level

tpLZ = output disable time from low level

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